

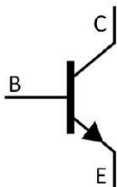
SOT-23

NPN

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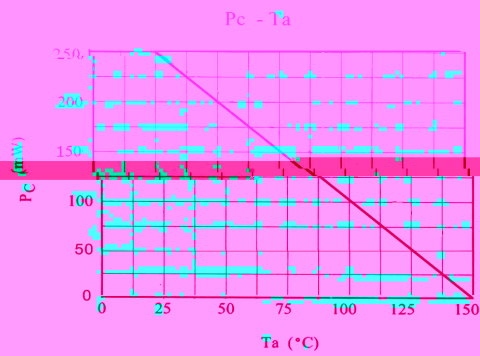
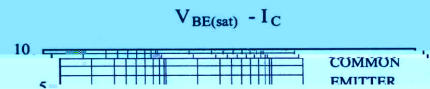
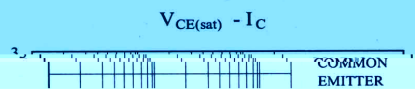
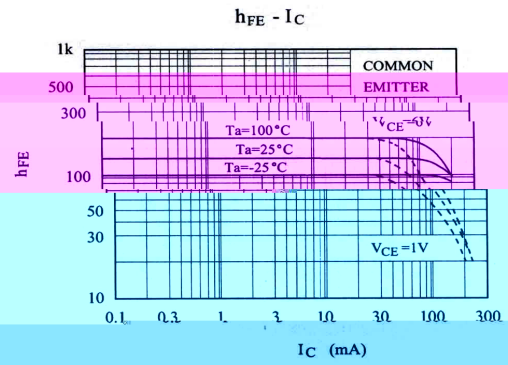
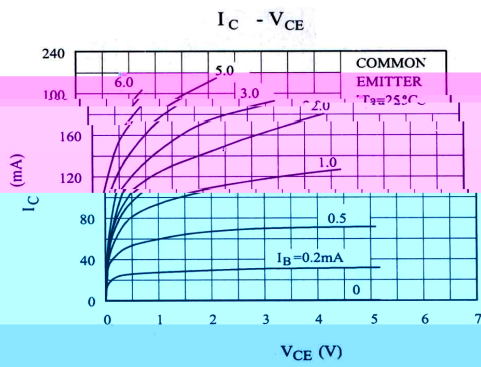
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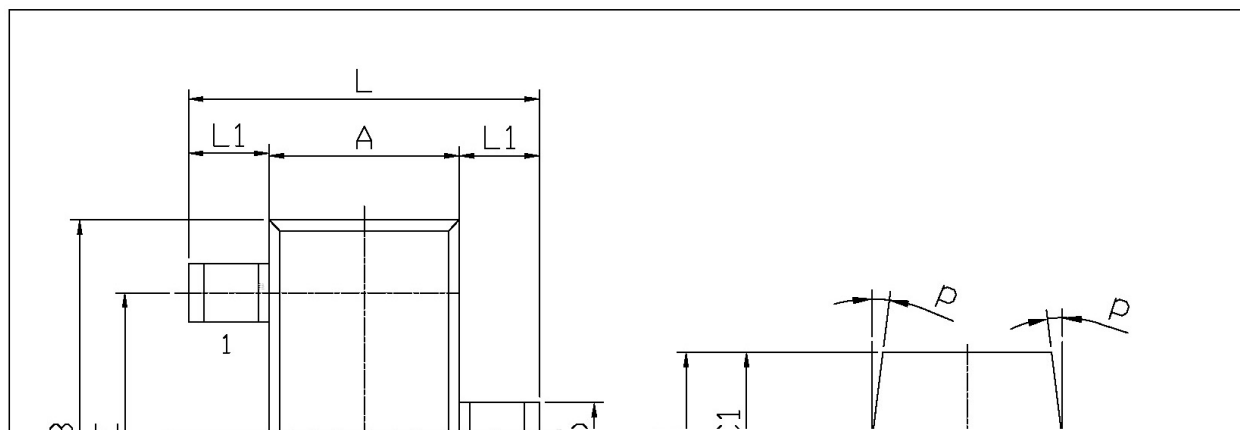
			°C
			°C

[illegible]

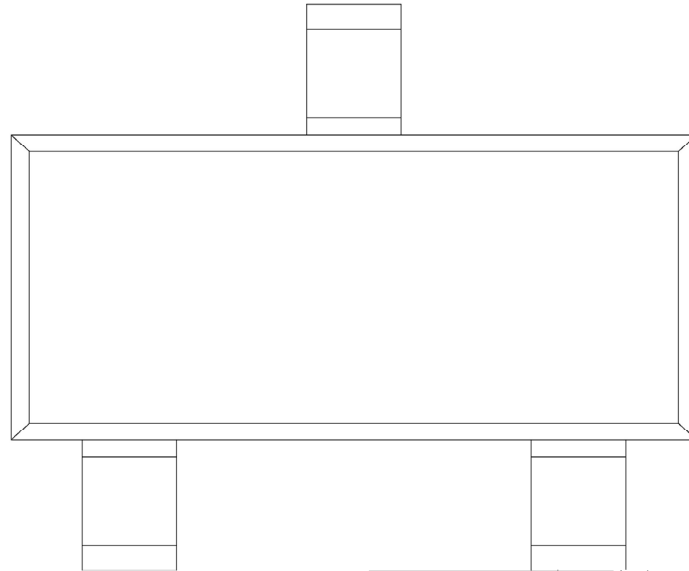


SOT-23

单位: mm



	MIN	MAX		MIN	MAX
L	2.2	2.7	C	1.30Max	
L1	0.45	0.65	C1	0.90	1.20
A	1.15	1.50	φ	0.05	0.25
B	2.70	3.10	K	0	0.10
E	1.70	2.10	M	0.20MIN	
E1	0.85	1.05	φ	7°	
b	0.35	0.55			



H

HF

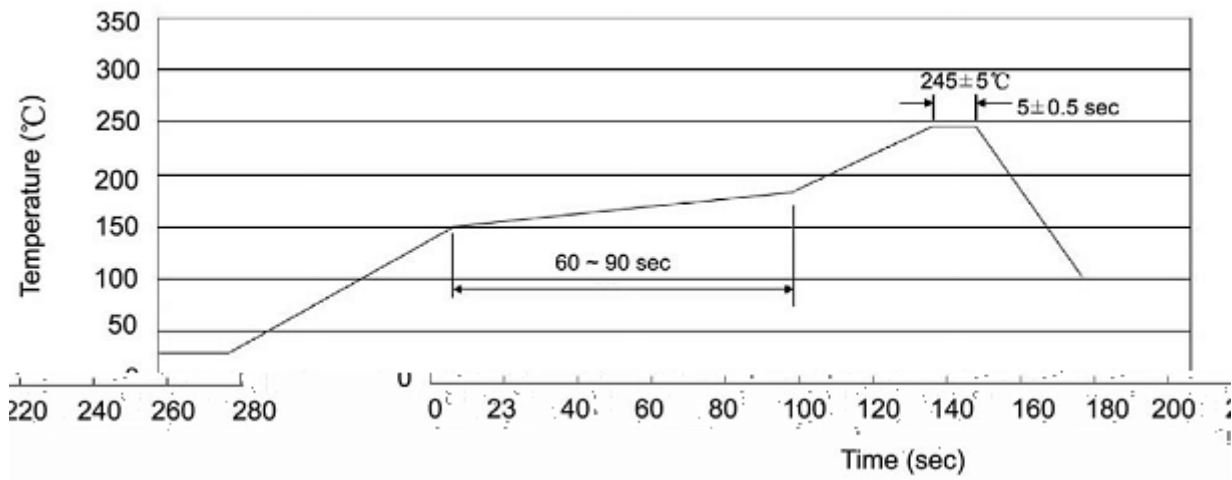
O

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H

O

Temperature Profile for IR Reflow Soldering(Pb-Free)



± ± ± ±

± ± ± ±

封装形式	包装数量					包装尺寸		
	Units/Reel 只/卷盘	Reels/Inner Box 卷盘/盒	Units/Inner Box 只/盒	Inner Boxes/Outer Box 盒/箱	Units/Outer Box 只/箱	Reel	Inner Box 盒	Outer Box 箱
SOT-23	3,000	10	30,000	6	180,000	7 ×8	180×120×180	390×385×205